

**Pb-free
HEAT**



MU04 Series

Single Color / Light Bar Module

Features

Light emitting surface (Outer size)	6 x 19 mm (7 x 20 mm) (L x W)
Product features	<ul style="list-style-type: none"> • Single Color (Green, Yellow Green, Orange or Red) • Lead-free soldering compatible • RoHS compliant
Peak wavelength	Green : 555 nm (5101,5105) : 560 nm (5102) Yellow Green : 570 nm (4101,4105) Orange : 605 nm (3101,3105) Red : 660 nm (2101,2105)
Die materials	Green, Yellow Green : GaP Orange : GaAsP Red : GaAlAs
Soldering methods	TTW (Through The Wave) soldering and manual soldering
Soldering methods	More than 2kV(HBM)
Packing	Plastic bag

Recommended Applications

Electric Household Appliances, OA/FA, Other General Applications

Color and Luminous Intensity

Part No.	Material	Emitted Color	Resin Color	Intensity ^{※1} I _v (mcd)			Number of Chips
				MIN.	TYP.	I _F	
MU04-5101	GaP	Green	Green	8	16	20	3
MU04-5105	GaP		Milky White	8	16	20	3
MU04-5102	GaP		Green	10	20	20	3
MU04-4101	GaP	Yellow Green	Yellow	15	32	20	3
MU04-4105	GaP		Milky White	15	32	20	3
MU04-3101	GaAsP	Orange	Orange	8	16	20	3
MU04-3105	GaAsP		Milky White	8	16	20	3
MU04-2101	GaAlAs	Red	Red	15	32	20	3
MU04-2105	GaAlAs		Milky White	15	32	20	3

※1 Luminous Intensity : 3 chips

Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings										Unit
		5101	5105	5102	4101	4105	3101	3105	2101	2105		
Power Dissipation ^{※2}	P _d	190	190	225	225	225	190	190	180	180	mW	
Forward Current	I _F	25	25	30	30	30	25	25	30	30	mA	
Pulse Forward Current ^{※3}	I _{FRM}	60	60	60	60	60	60	60	60	60	mA	
Derating (Ta=25°C or higher)	ΔI _F	0.33	0.33	0.40	0.40	0.40	0.33	0.33	0.40	0.40	mA/°C	
	ΔI _{FRM}	0.80	0.80	0.80	0.80	0.80	0.80	0.80	0.80	0.80	mA/°C	
Reverse Voltage	V _R	4	4	4	4	4	4	4	4	4	V	
Operating Temperature	T _{opr}	-40~+85										°C
Storage Temperature	T _{stg}	-40~+85										°C

※2 Power Dissipation : 3chips, The other Items : 1 chip

※3 I_{FRM} Measurement condition : Pulse Width ≤ 2ms, Duty ≤ 1/5

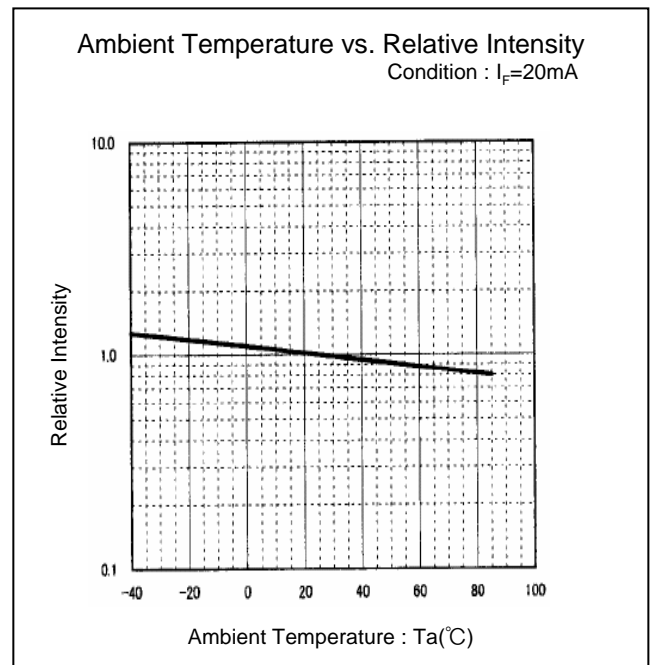
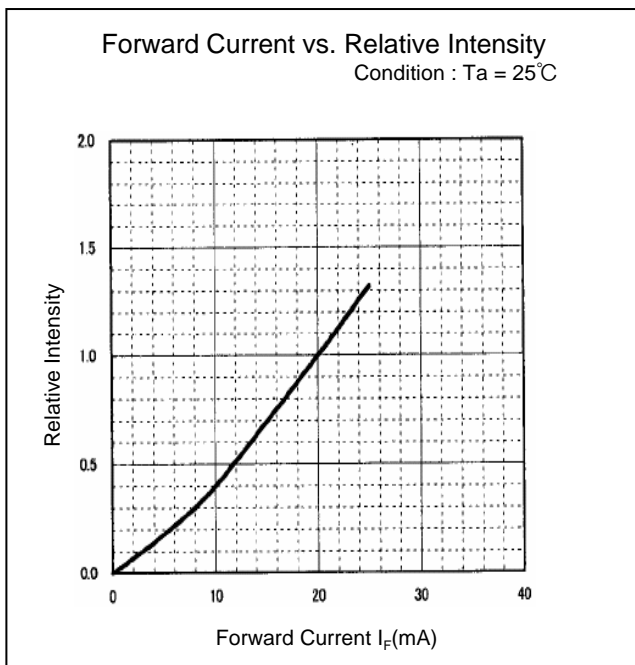
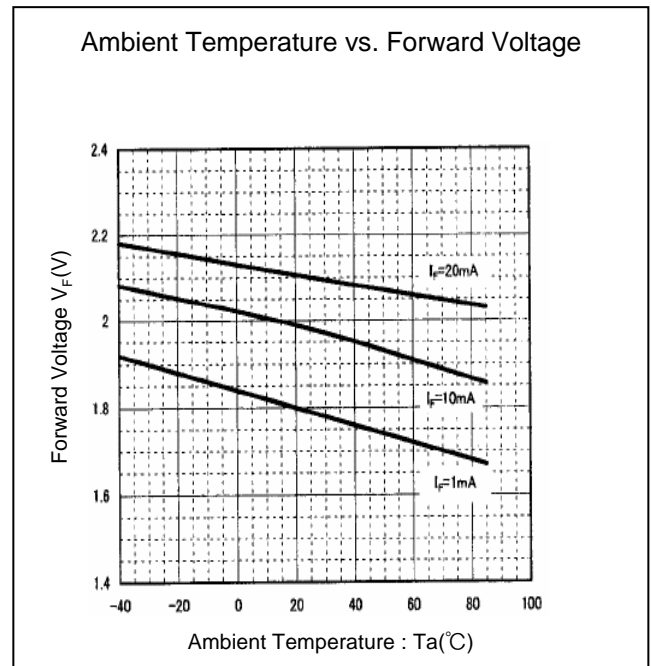
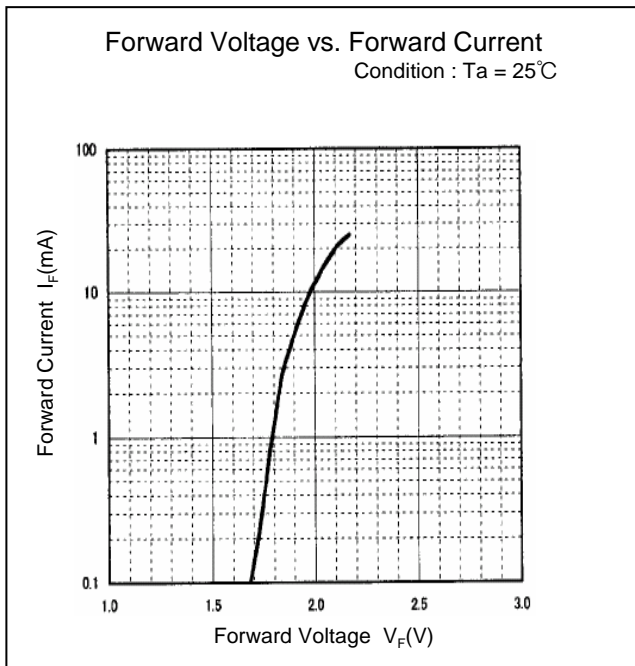
Electro-Optical Characteristics

(Ta=25°C)

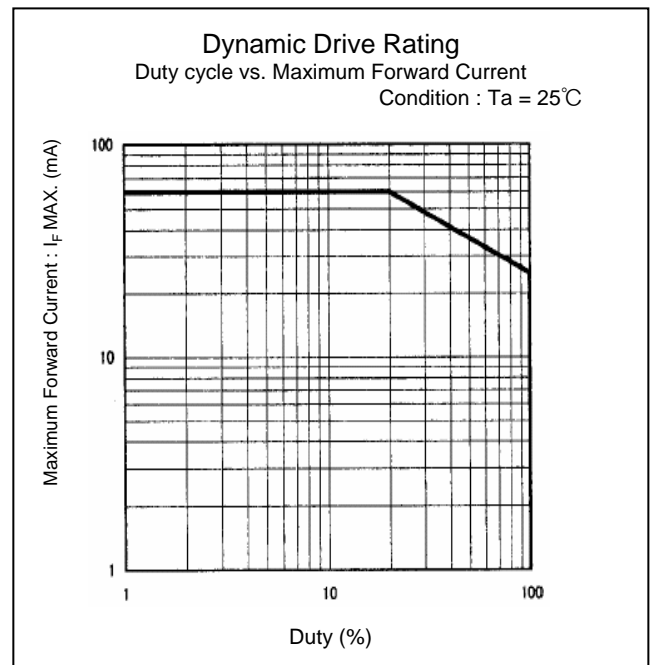
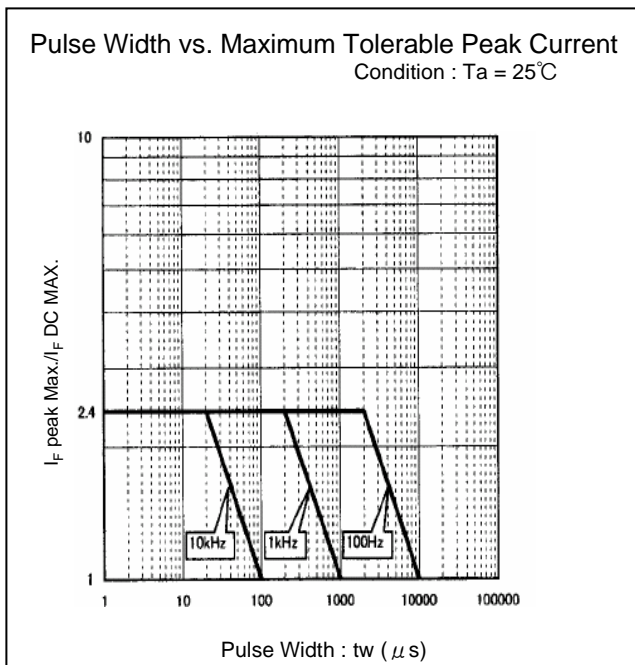
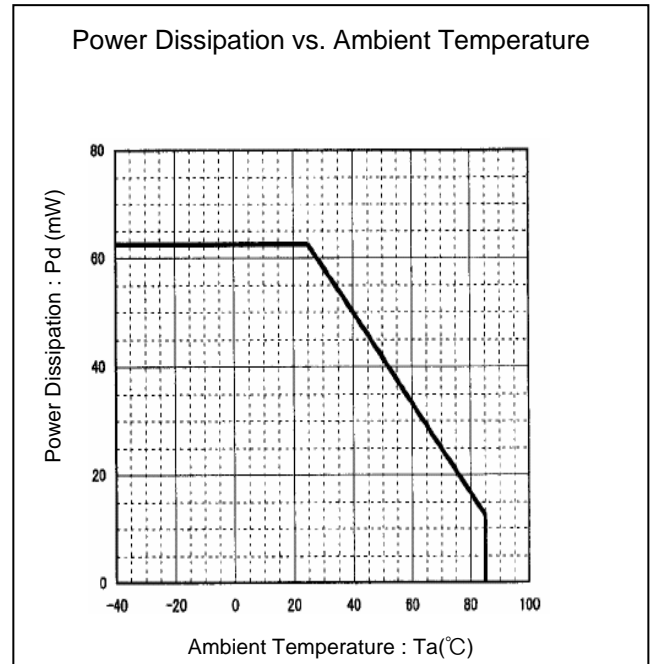
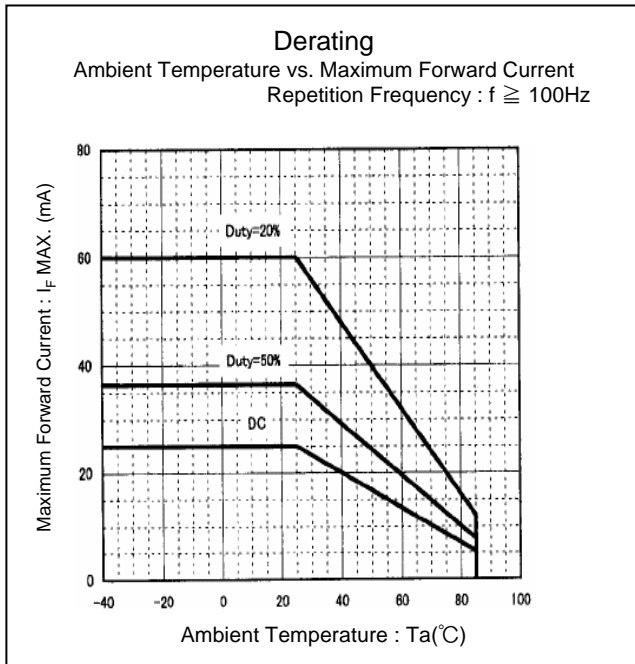
Item	Conditions	Symbol		Characteristics										Unit
				5101	5105	5102	4101	4105	3101	3105	2101	2105		
Forward Voltage	I _F =20mA	V _F	TYP.	2.2	2.2	2.1	2.1	2.1	2.2	2.2	1.7	1.7	V	
			MAX.	2.5	2.5	2.5	2.5	2.5	2.5	2.5	2.5	2.0		2.0
Reverse Current	V _R =4V	I _R	MAX.	100	100	100	100	100	100	100	100	100	μA	
Peak Wavelength	I _F =20mA	λ _p	TYP.	555	555	560	570	570	605	605	660	660	nm	
Spectral Line Half Width	I _F =20mA	Δλ	TYP.	30	30	30	30	30	30	30	30	30	nm	

※ The above Items : 1 chip

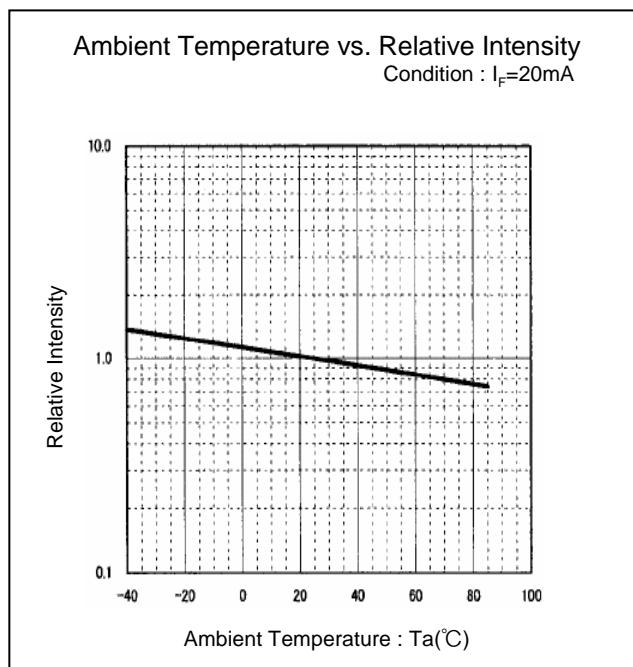
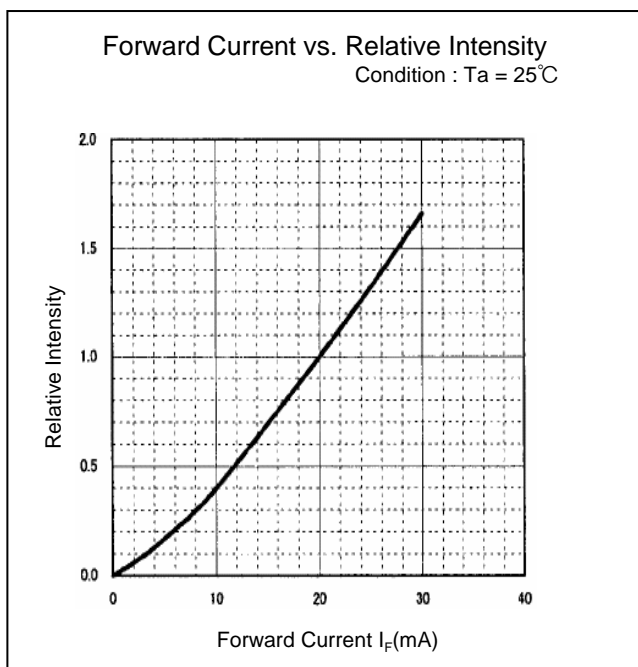
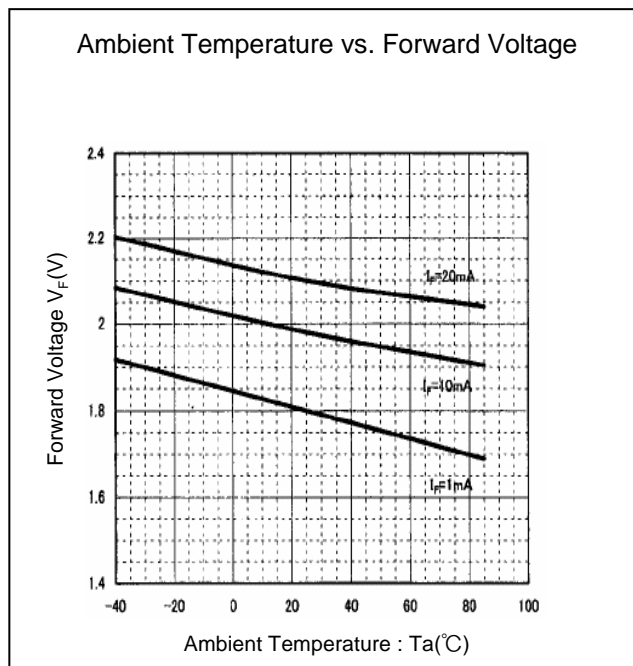
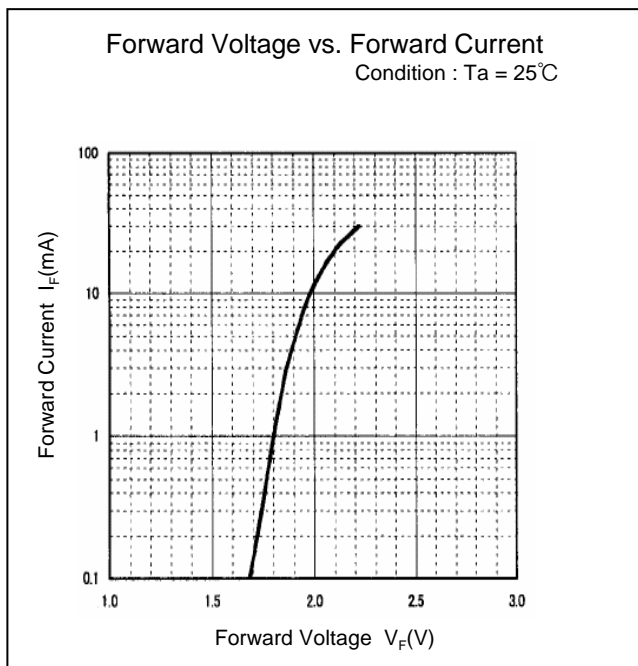
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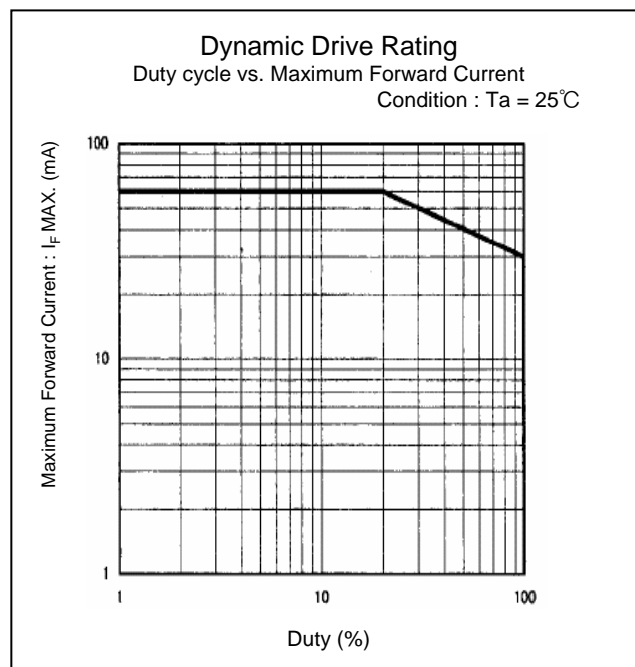
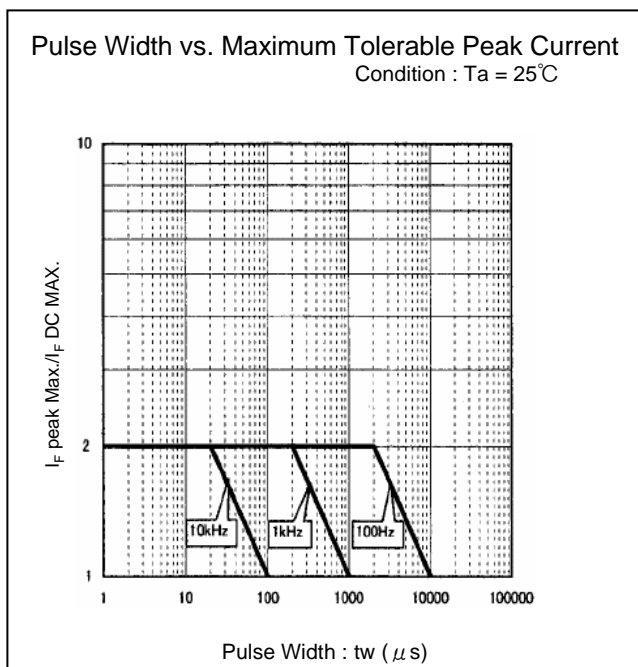
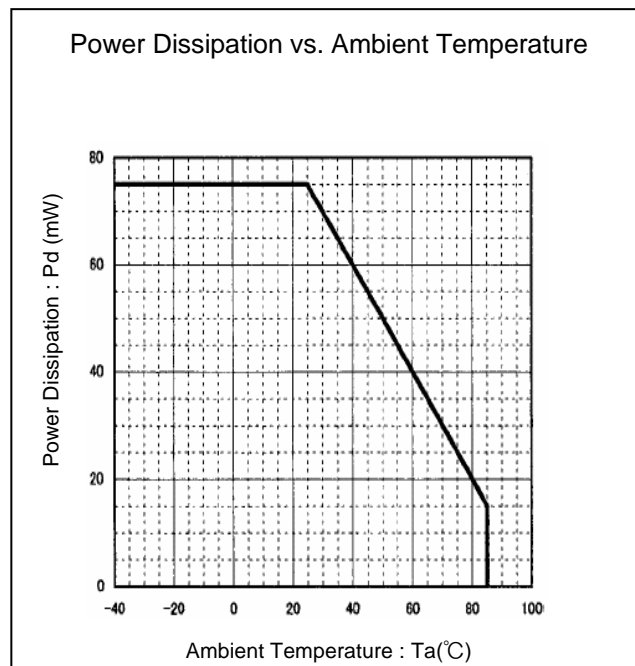
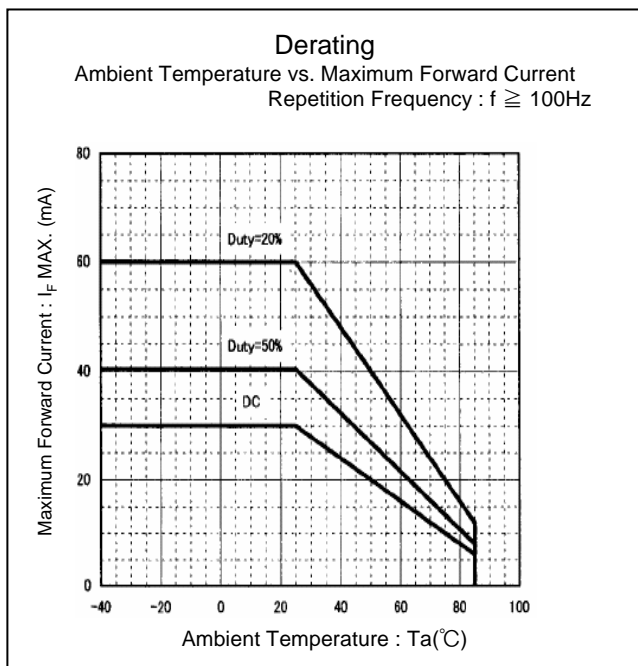
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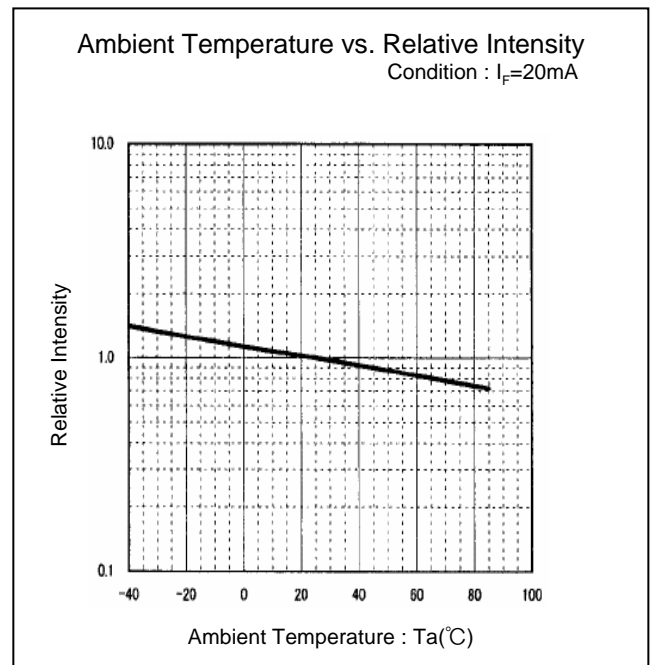
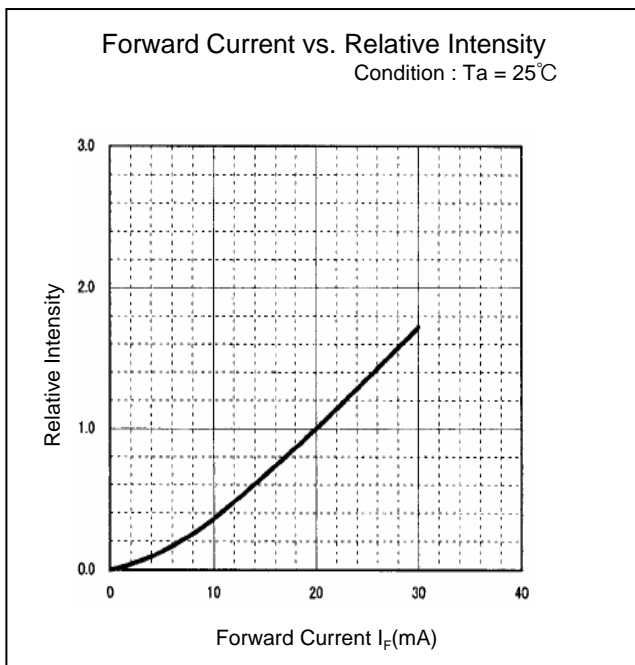
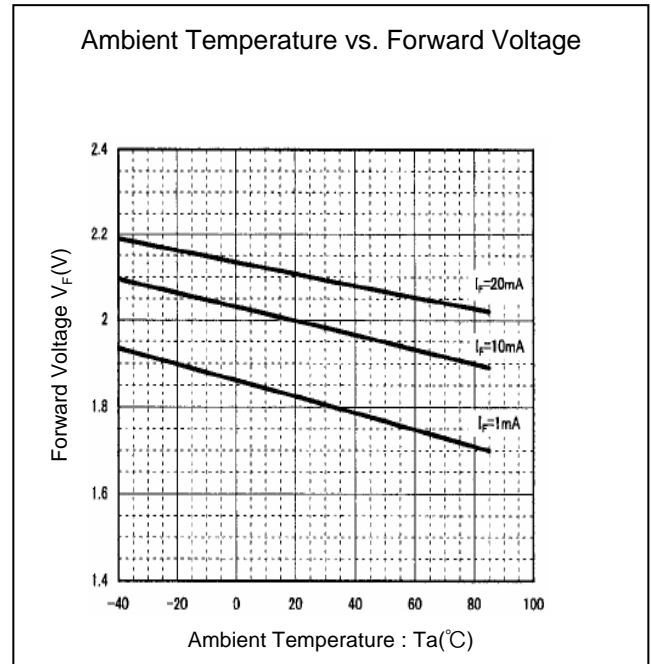
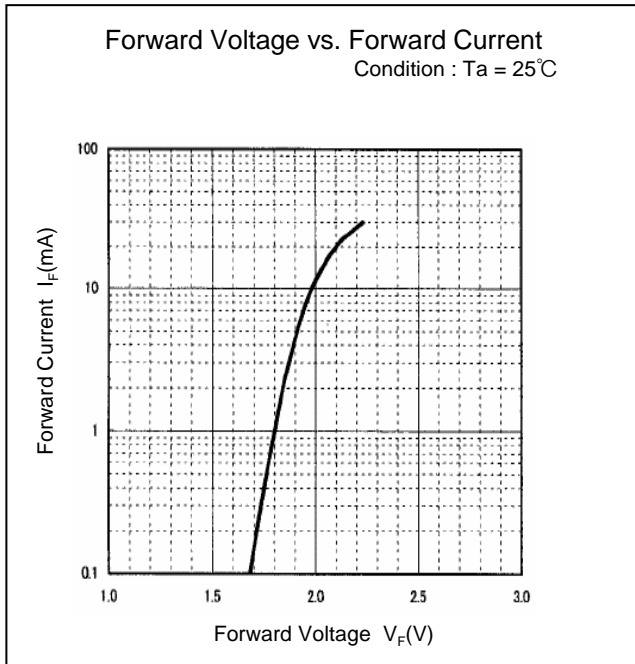
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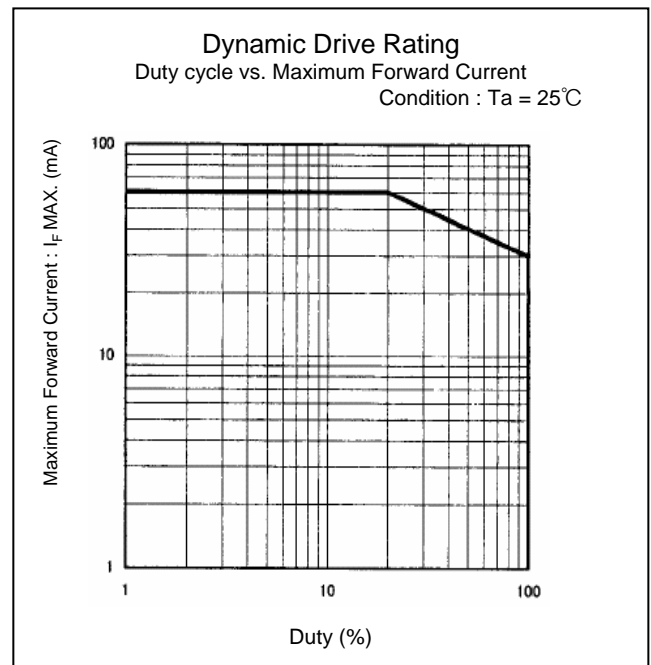
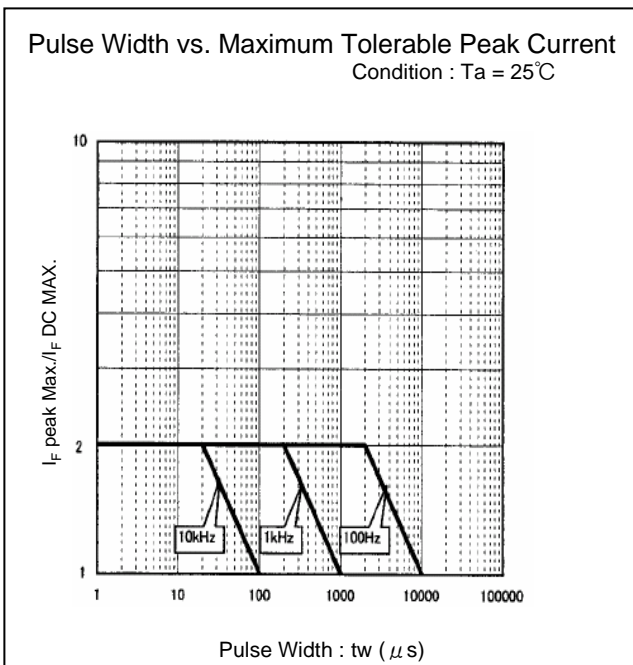
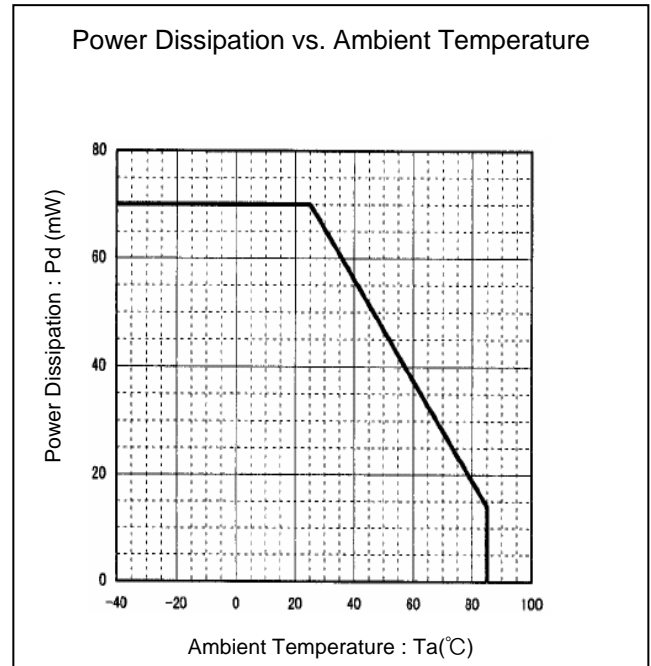
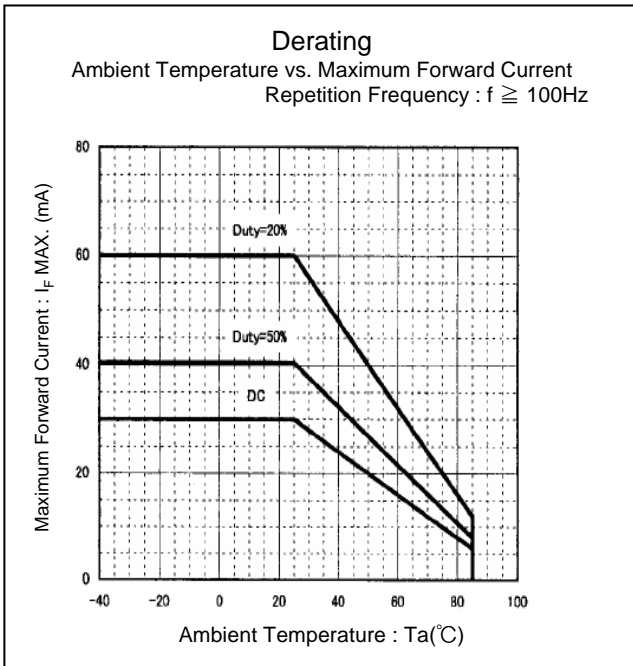
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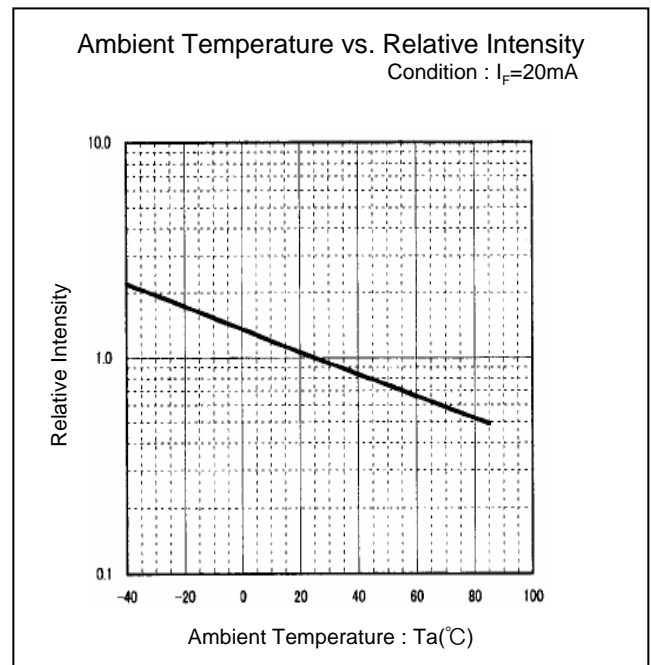
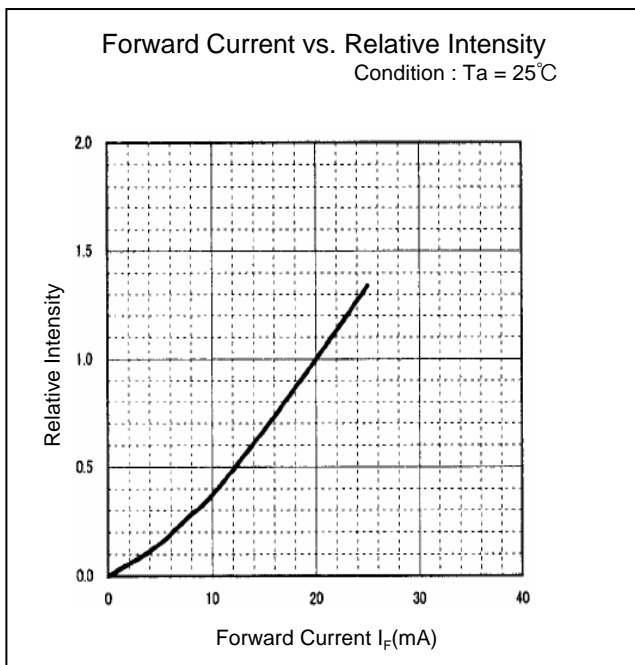
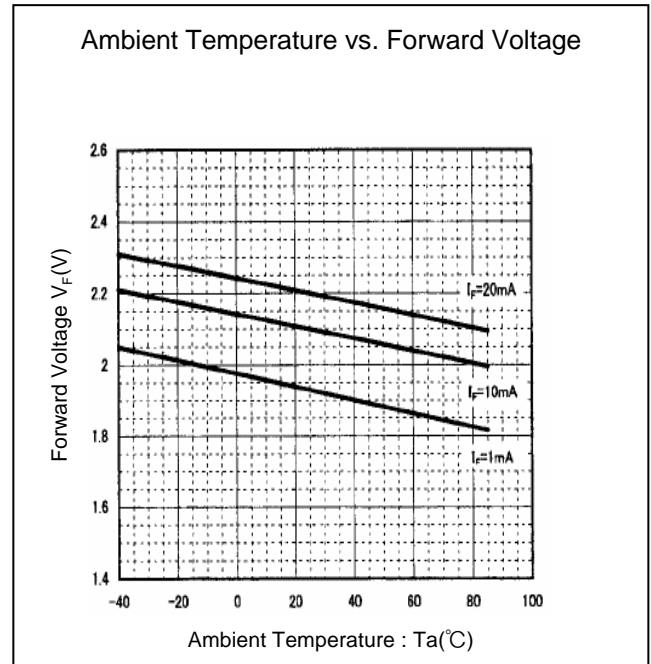
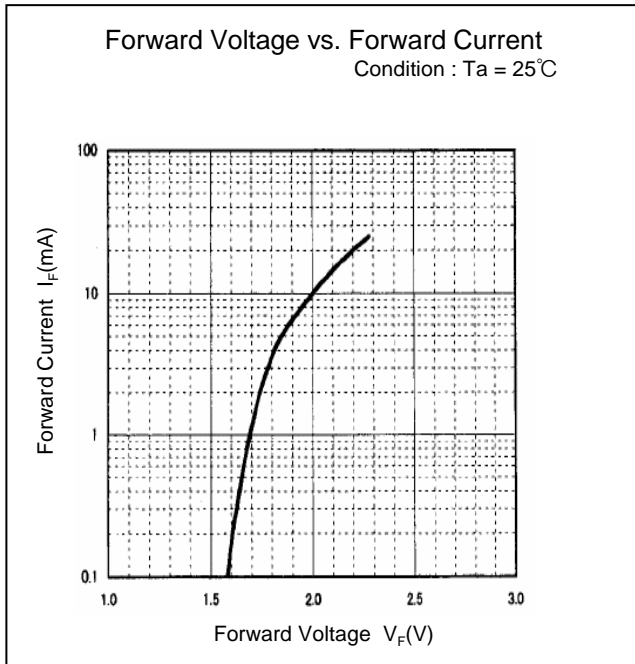
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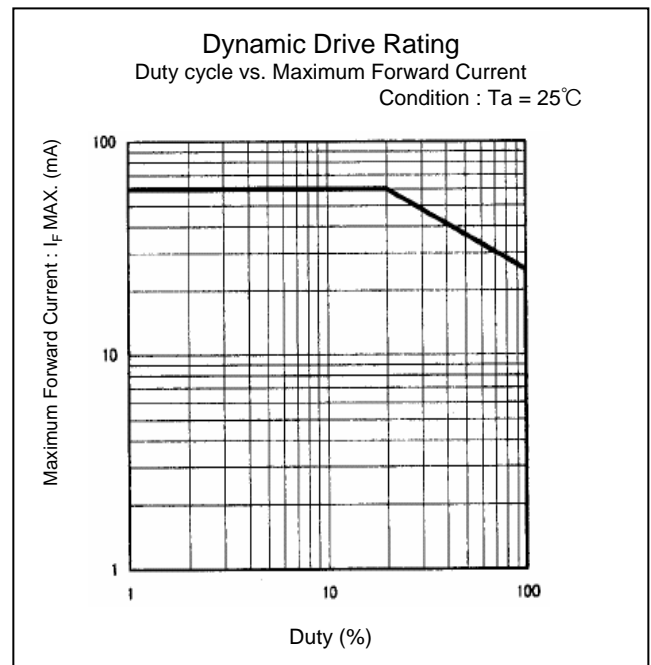
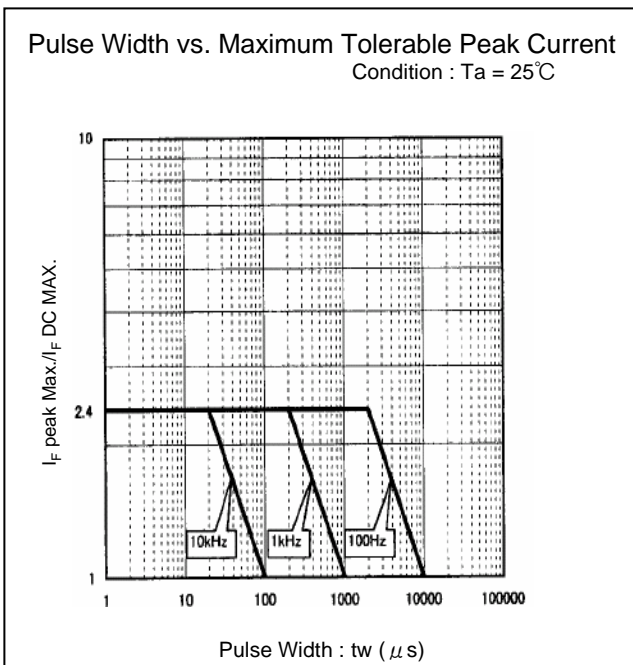
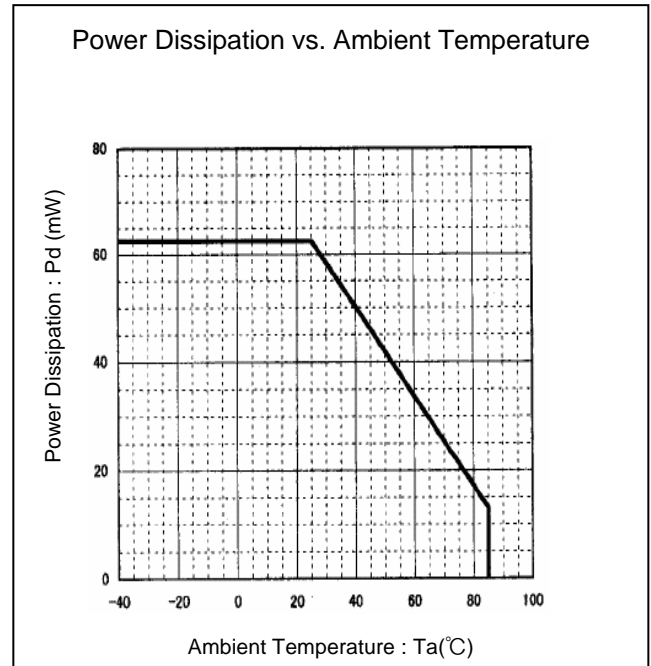
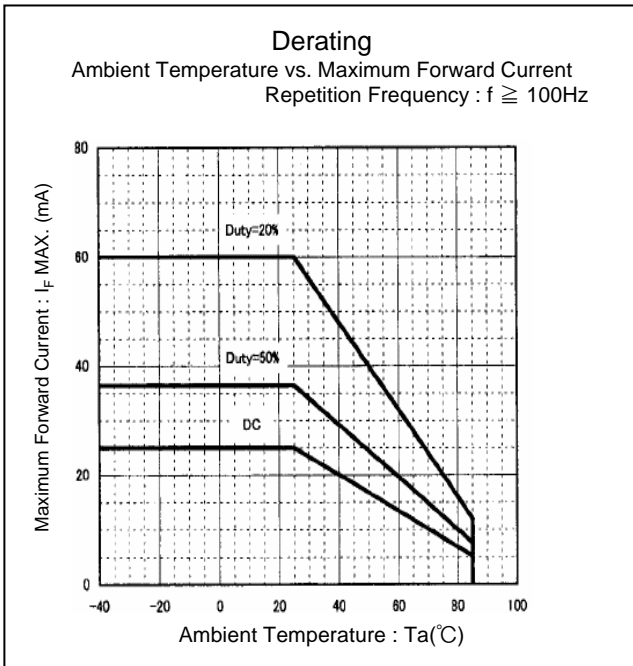
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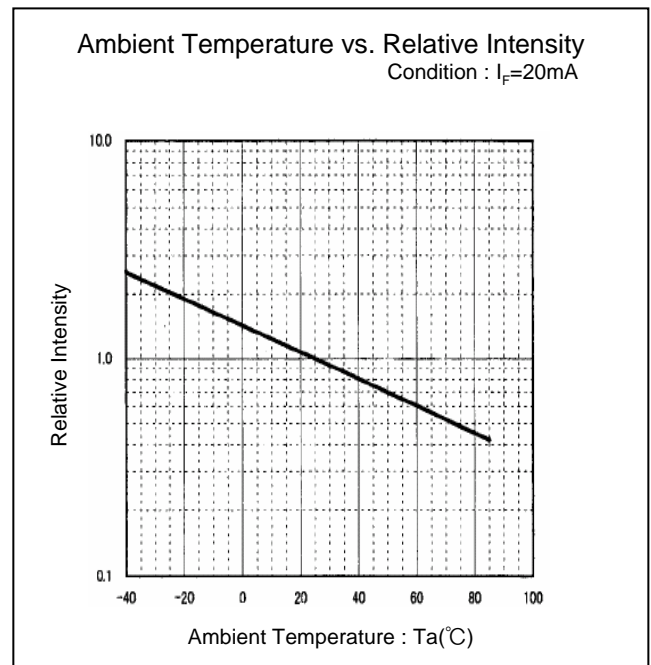
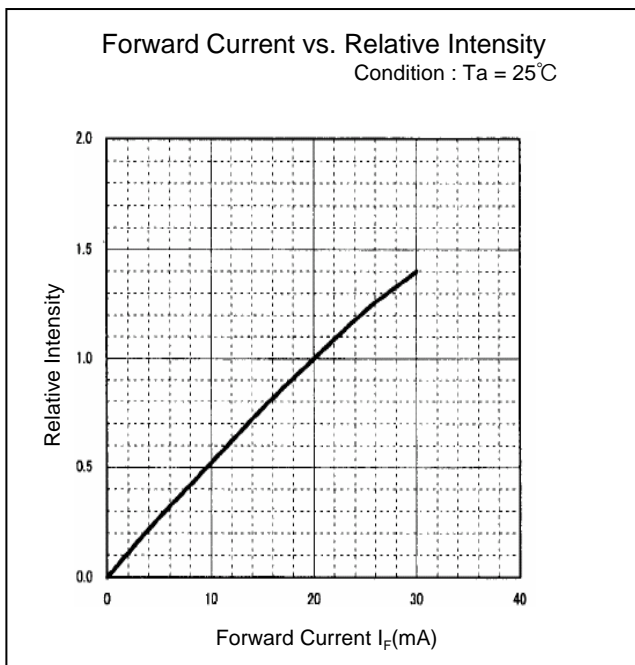
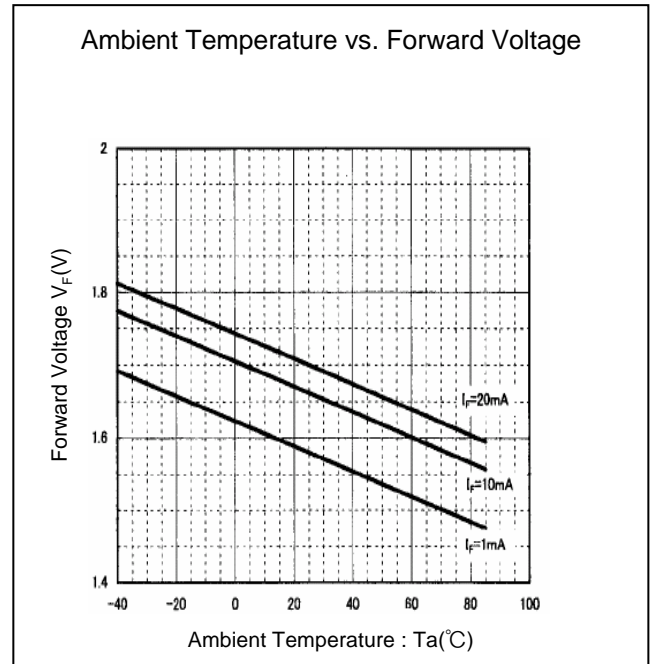
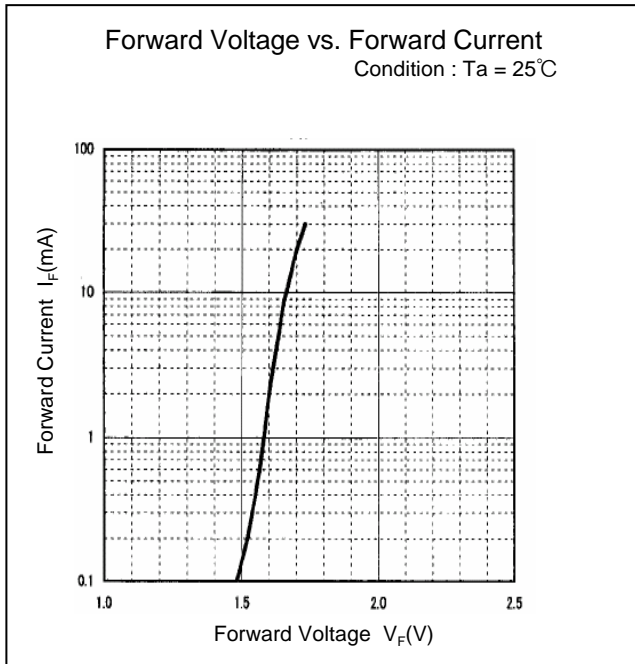
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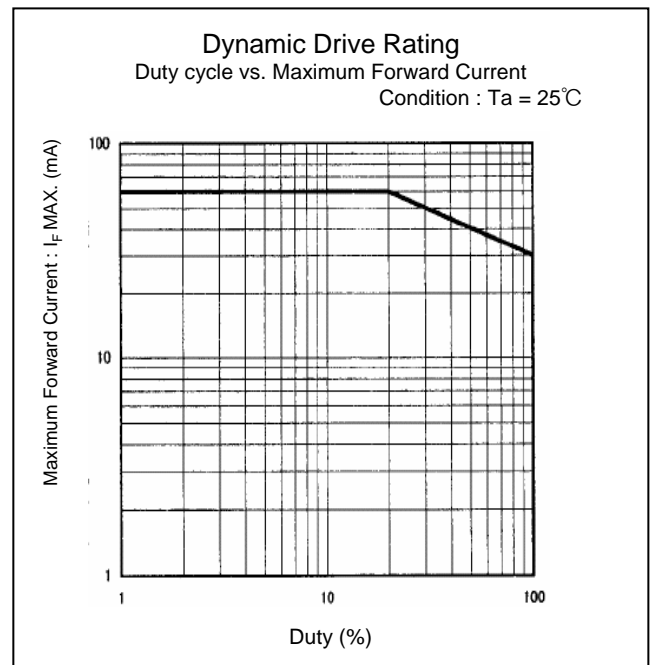
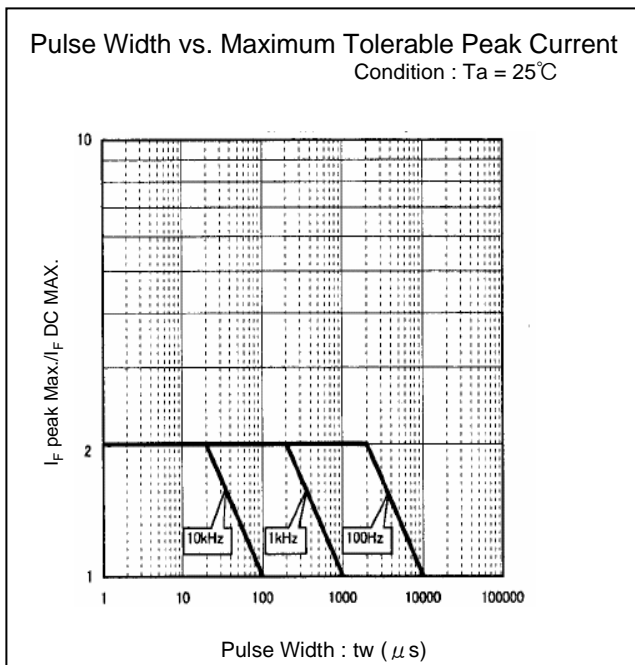
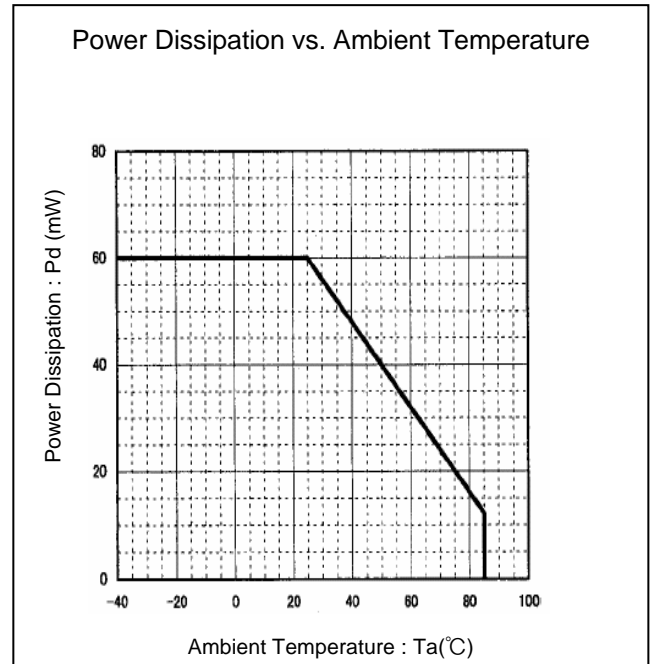
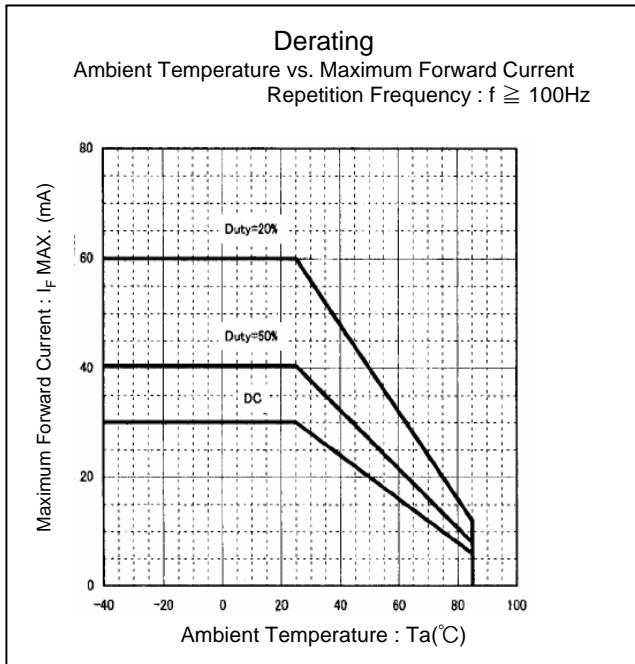
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Technical Data(2101/2105)



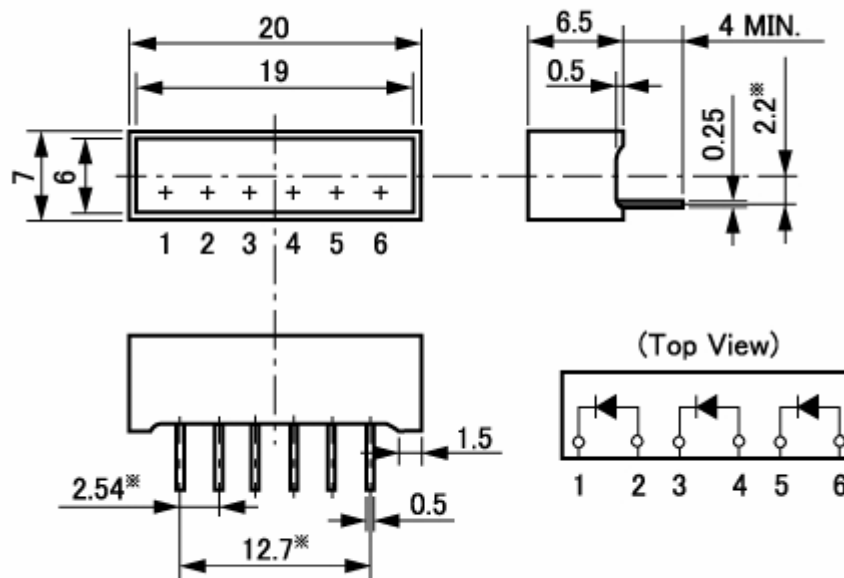
Technical Data(2101/2105)



Package Dimensions

(Unit: mm)

(Tolerance : ± 0.25 mm)



● ※ mark : The measure of lead root

TTW (Through The Wave) soldering Conditions

Pre-heating	100 °C 60 s	(MAX.) Resin surface temperature (MAX.)
Solder Bath Temp.	265 °C	(MAX.)
Dipping Time	5 s	(MAX.)
Position	At least 2.0 mm away from the root of lead	

- 1) The dip soldering process shall be 2 times maximum.
- 2) The product shall be cooled to normal temperature before the second dipping process.

Manual Soldering Conditions

Iron tip temp.	400 °C	(MAX.) (30 W Max.)
Soldering time and frequency	3 s 2 times	(MAX.) (MAX.)
Position	At least 2.0 mm away from the root of lead	

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EAJED-4701/100(101)	Ta = 25°C, If = Maximum Rated Current	1,000 h	0/10
Resistance to Soldering Heat	EAJED-4701/300(302)	260±5°C, 3mm from package base	10s	0/10
Temperature Cycling	EAJED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min)	5 cycles	0/10
Wet High Temp. Storage Life	EAJED-4701/100(103)	Ta = 60±2°C, RH = 90±5%	1,000 h	0/10
High Temp. Storage Life	EAJED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/10
Low Temp. Storage Life	EAJED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/10
Lead Tension	EAJED-4701/400(401)	5N, 1time	10s	0/10
Vibration, Variable Frequency	EAJED-4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10
Lead Bend	EAJED-4701/400(401)	2.5N, 0°←→ 90°	Twice	0/10
Shock	JSC 7201 A-8	It falls on wood engraving from height of 75cm.	3 times	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	Iv	If=20mA	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V _F	If=20mA	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I _R	V _R =4V	Testing Max. Value ≥ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	Occurrence of notable decoloration, deformation and cracking

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